



CALL FOR PAPERS

25th IEEE/ACIS International Summer Conference on Software Engineering, Artificial Intelligence, Networking and Parallel/Distributed Computing

(SNPD2023-Summer)

July 5-7, 2023

Taiyuan, China

<http://www.acisinternational.org/snpd2023/>

Sponsored by ACIS, USA
and North University of China, China



Important Dates

Workshop/Special session proposal:	January 13, 2023
Workshop/Special session acceptance notification:	January 27, 2023
Full/Poster Paper submission:	March 4, 2023 Extended: May 15, 2023
Acceptance notification:	March 19, 2023 Extended: May 30, 2023
Registration & camera-ready papers:	April 2, 2023 Extended: June 13, 2023
Conference Dates:	July 5-7, 2023

SNPD 2023-Summer Proceedings will be published by IEEE Conference Publishing Services and will be submitted to be indexed by EI, INSPEC, and DBLP

Conference officers will select outstanding papers for publication in the following journals (www.acisinternational.org):

- *International Journal of Networked and Distributed Computing (IJNDC), Paris, France*
- *International Journal of Software Innovation (IJSI), IGI Global, U.S.A.*
- *International Journal of Big Data Intelligence and Applications (IJBDA), IGI Global, U.S.A.*
- *Studies in Computational Intelligence (SCI), Springer, Germany*

Best Paper Award and Best Student Paper Awards will be conferred at the conference (in order to qualify for the award, the paper must be presented at the conference.)

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